



NOTE :

1. DIMENSIONS IN MILLIMETERS. ANGLES IN DEGREES.
2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
3. REFER JEDEC MO-229.
4. RECOMMENDED LAND PATTERN IS FOR REFERENCE ONLY.
5. THERMAL PAD SOLDERING AREA

	DATE: 10/22/09
	DESCRIPTION: 10-pin, Very Thin Fine Pitch Dual Flat No Lead (TDFN)
	PACKAGE CODE: ZE (ZE10)
	DOCUMENT CONTROL #: PD-2092
REVISION: A	